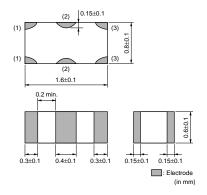
Data Sheet

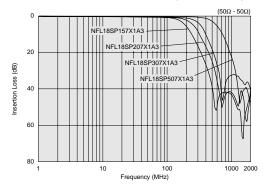
EMIFIL® (LC Combined) Multilayer Type

NFL18SP Series (0603 Size)

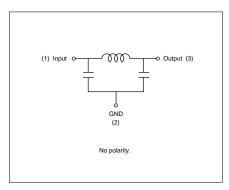
■ Dimensions



■ Insertion Loss Characteristics (Main Items)



■ Equivalent Circuit



■ Packaging

Code	Packaging	Minimum Quantity		
D	180mm Paper Tape	4000		
В	Bulk(Bag)	1000		

■ Rated Value (□: packaging code)

Part Number	Nominal Cut-off Frequency	Capacitance	Inductance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Withstand Voltage	Operating Temperature Range
NFL18SP157X1A3□	150MHz	34pF ±20	100nH ±20%	100mA	10Vdc	1000M ohm	30Vdc	-55 to +125°C
NFL18SP207X1A3□	200MHz	24pF ±20	80nH ±20%	100mA	10Vdc	1000M ohm	30Vdc	-55 to +125°C
NFL18SP307X1A3□	300MHz	19pF ±20	60nH ±20%	100mA	10Vdc	1000M ohm	30Vdc	-55 to +125°C
NFL18SP507X1A3□	500MHz	11pF ±20	38nH ±20%	100mA	10Vdc	1000M ohm	30Vdc	-55 to +125°C

Number of Circuits: 1

■ ①Caution/Notice

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

● This data sheet is applied for LC Combined CHIP EMIFIL® used for General Electronics equipment for your design.

⚠ Note:

- 1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

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